

Revision Description*:

Product/Process Change Notice - PCN 09_0060 Rev. -

Analog Devices, Inc. Three Technology Way Norwood, Massachusetts 02062-9106

This notice is to inform you of a change that will be made to certain ADI products (see Material Report). Any issues with this PCN or requirements to qualify the change (additional data or samples) must be sent to ADI within 30 days of receiving this notification. ADI contact information is listed below.

Initial Release				
PCN Title:	ADT7470 Metal mask edit			
Publication Date:	08-Apr-2009			
Samples Available Date:	24-Mar-2009			
Effectivity Date:	08-Apr-2009 (the earliest date that a customer could expect to receive changed material)			
Description Of Change				
Metal mask edit to fix overfl	ow problem.			
Reason For Change				
	n conjunction with the TMP05, it was observed that an overflow problem arose as temperature was ramped. To address this, an edit . There is no change to datasheet.			
Anticipated impact of the c	hange (positive or negative) on fit, form, function & reliability			
Positive change - fixes overf	low issue. No impact on any other aspect of the part's form, fit, function, quality or reliability.			
Product Identification (this	section will describe how to identify the changed material)			
Date code 0851 and from 09	15 onwards.			
Summary of Supporting In	formation			
Bench test evaluations.				
Supporting Documents	None			
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Appendix A - Affected ADI Parts - Generic Number / Material Number (7)						
ADT7470 / ADT7470ARQ	ADT7470 / ADT7470ARQ-REEL	ADT7470 / ADT7470ARQ-REEL7	ADT7470 / ADT7470ARQZ	ADT7470 / ADT7470ARQZ-REEL	ADT7470 / ADT7470ARQZ-REEL7	
ADT7470 / EVAL-ADT7470EBZ						

Appendix B - Revision History					
Rev	Publish Date	Rev Description			
Rev	08-Apr-2009	Initial Release			

Analog Devices, Inc. Proprietary Information

DocId:689 Parent DocId:None